

## Index

### a

absorbing-film assisted laser-induced forward transfer (AFA-LIFT) 66, 351  
 absorption efficiency 243  
 acousto-optical modulator (AOM) 382  
 active-matrix OLED (AMOLED) displays 7  
 prototype devices 30  
 additive manufacturing 266  
 Alexa 594 labeled lambda phage DNA 310  
 amperometric biosensor 311  
 amyloid peptides 337, 338  
 avidin 334

### b

BA-LIFT *see* blister-actuated laser-induced forward transfer (BA-LIFT)  
 ballistic laser-assisted solid transfer (BLAST) 177–179  
 bio-electronic nose 339  
 Biological Laser Printing (BioLP) 66, 351  
 BioLP process 357  
 biomicrodevices 329  
 bioprinting 349  
 biosensors 299  
 blade coating 23, 129–130  
 blister-actuated laser-induced forward transfer (BA-LIFT) 66, 92  
 blister formation

dynamics 97–102  
 finite element modeling 102–105  
 cavitation bubble collapse 96  
 delicate materials 113–117  
 experimental setup 92  
 jet formation 92  
 jet formation and expansion  
 computational fluid dynamics model 106–108  
 ink film properties 111–113  
 laser energy 108–111  
 laser absorption 96  
 liquid ejection 95  
 liquid jets 97  
 mechanism 92  
 penetration or absorption depth 94  
 polyimide 93  
 polymer laser-absorbing layer 93  
 pump-probe imaging 94  
 solvent orthogonality 93  
 thick polymer layer 92  
 time-resolved imaging 92  
 vapor cavity 96  
 blister formation  
 dynamics 97–102  
 finite element modeling 102–105  
 boundary deformation function 244  
 domain perturbation method 239–40, 239–40  
 kinetic energy 242, 243  
 velocity components 240, 241  
 “blow-off time” 166

**C**

cancer research 359  
 capacitive DNA biosensor 310  
 CdSe(CdS) nanoquantum dots 285  
 cell printing 350  
 centripetal acceleration 37  
 chalcogenide thin films 189–190  
 chemical and biological sensors  
   applications 316  
   background of biosensors 308  
   carbon nanotubes 318  
   electrospray deposition 304, 305  
   inkjet printing technique 304  
   laser-Induced forward transfer (LIFT) 305, 307  
   LIFT of liquid films 307, 308  
   microcontact printing 302  
   nano-tip printing technique 303  
   photochemistry-based printing 303  
   pin printing approach 301, 302  
   polyepichlorohydrin (PECH) polymer/carbon 318  
   printing of biological materials 309, 316  
 chemoresistor gas sensors 318  
 colorimetric enzyme linked immunosorbent assay (ELISA) 337  
 congruent LIFT, *see* laser decal transfer (LDT)  
 contact printing methods  
   microcontact printing 302  
   nano-tip printing technique 303  
   pin printing approach 301, 302  
 coplanar waveguide (CPW) 239  
 cytoscribing 350

**d**

digital micromirror device (DMD) 176, 235, 236  
   advantages 181  
   experimental setup 182  
   pattern 181  
   polymer films 181  
 digital printing 376

dip coating 23, 129, 130  
 diPhAc-3T (Bis(2-phenylethynyl end-substituted terthiophene) 276  
 dip-pen lithography 303  
 direct-matrix absorption (DMA) 92  
 direct patterning methods 330  
 “direct-write” approaches 27  
 dispensing or soaking techniques 330  
 distyryl-quaterthiophene (DS4T) 276  
 DMD-based pulse shaping, LIBT 195  
 “8–17” DNAzyme 313  
 doctor blading, *see* blade coating  
 dot-blotting 330  
 drawdown rods method 23  
 droplet mode deposition  
   contact and non-contact configurations 160  
   copper droplets 162  
   donor film 161  
   droplet velocity 163  
   femtosecond excimer LIFT 160  
   jet instability 162  
   jetting phenomena 163  
   liquid jets 67, 163  
   mechanism 69, 163  
   microscale 3D printing 163  
   multiple droplets per laser pulse 162  
   nanosecond LIFT of aluminum 161  
   printing lines 78–81  
   transfer droplet 69, 72, 161  
 dynamic release layer (DRL) 24, 92, 306, 331  
   advantage 124  
   explosive polymers 124  
   laser absorption 124  
   trace material 124  
 dynamics process 431  
   lase-and-place 432–435  
   laser transparent carrier tapes 431  
   polyimide blistering layer 432  
   silicon substrates 431  
   thermo-mechanical selective laser-assisted die transfer 431

**e**

electrical resistivity 164  
 electrochemical biosensors 300

electron lithography 254  
 electrospray deposition 304, 305  
 energy harvesting 286  
   chalcogenide thin films 189–190  
   thermoelectric generator 190–193  
 enzyme linked immunosorbent assay  
   315  
 explosive polymers 124

## f

femtosecond laser  
   printing 251  
   system 178, 180  
 FF-LIFT, *see* film-free LIFT (FF-LIFT)  
 film-formation methods 23  
 film-free laser printing (FF-LP)  
   technique 5, 67  
 film-free LIFT (FF-LIFT) 125  
   applications 140  
     micro-optical elements fabrication  
     140  
   printing biomaterials 139–140  
 forward (inverted) *vs.* backward  
   (upright) systems 137  
 fundamentals of  
   cavitation-induced phenomena  
     131–132  
   jet formation 132–133  
   *vs.* LIFT 134  
 implementation and optical  
   considerations  
   forward (inverted) *vs.* backward  
   (upright) systems 136–137  
   laser source 135–136  
   spherical aberration and chromatic  
   dispersion 137–138  
 jet formation 132–134  
*vs.* LIFT 135  
 micro-optical elements fabrication  
   141  
 receiver substrate 130–131  
 spherical aberration and chromatic  
   dispersion 137–138  
 thin liquid film preparation  
   blade coating 129, 130  
   dip coating 129, 130

external instabilities 125–126,  
   128–129  
   rheological parameters 126  
   spin coating 129, 130  
   spontaneous instabilities 125,  
     126–128  
   traditional LIFT 123, 124  
   transparent liquids 124, 125  
 finite-element analysis software 187  
 finite element modeling 102–105  
 flexography 271  
 flip-chip technology 289  
 fluence threshold value 178  
 fluids 63  
   ejection and deposition  
     droplet deposition 69–71  
     jet formation 67–69  
   printing continuous patterns 78  
   printing droplets  
     fluid properties 76, 77  
     laser parameters 69, 72–75  
     setup parameters 76–78  
   printing lines 78–81  
 fluorescently tagged complementary  
   proteins 27  
 focussed ion beam (FIB) 180, 416  
 Fresnel diffraction 178  
 fs-LIFT technique 25  
 fully polymeric OTFT devices 279  
 functional release layer (FRL) 240

## g

Gaussian/'top-hat' spatial intensity  
   beam profile 181  
 gentle hydration method 340  
 gravure printing 271

## h

horizontally-aligned grain boundaries  
   416  
 horseradish peroxidase (HRP) 335  
 hybrid circuits 427  
 hydrodynamic process 253  
 hydrogen-assisted laser-induced  
   forward transfer  
   (HA-LIFT) 28

**i**

immunoglobulin (IgG) microarrays  
312

inclined pillars 420

inkjet printing 38, 304, 330, 350

intact polymer molecules 8

interconnection and heterogeneous  
integration 287, 288, 290

interdigitized electrodes 289

interference effects 177

isotropic conductive adhesive (ICA)  
289

**j**

jet-and spray-ejection regime 409

jet formation dynamics 67, 201

experimental set up 201

Newtonian glycerol solutions

experimental design 202

fluid properties and laser fluence  
204, 205

jettability phase diagram 206–208

typical jetting regimes 202, 203

viscoelastic alginate solutions

alginate concentration effects  
214, 216

experimental design 208, 209

ink coating preparation 208

jettability phase diagram 215, 217

laser fluence effects 212, 215

material properties 209

non-dimensional numbers 209

typical jetting regimes 209, 210

jet formation mechanism 67, 96, 200

jet morphology 200

JetXpert imaging system 202

**l**

large area, high throughput LIFT/LIBT  
inline R2R-printing system  
387, 388

lase-and-place 428, 432–435, 440

laser ablation transfer (LAT) 7, 24, 306

laser-assisted bioprinting (LAB) 66

blood vessels 362

bone 365, 367

cancer research 359

effect of laser process and printing  
parameters 356, 358

heart 364, 365

history of cell bioprinting 349, 354

nervous system 367, 368

skin 360, 362

technical specifications 353, 356

laser-based non-lithographic processes  
428

laser-based printing/marketing process  
6

laser decal transfer (LDT) 66, 228

arrays 233

high viscosity donor material 234

thicker and thinner voxels 233

absorption efficiency 243

congruent laser transfer 244, 245

CPW 239

DMD 235–237

edge acuity 232

EDX analysis 239

fabricated LDT features 241

FRL 240

high-aspect 3D stacks and  
freestanding structures 234

intrinsic and engineered  
characteristics 230

laser system and experimental setup  
229

low-viscosity Ag ink vs. high-viscosity  
Ag nanopaste 242

mechanical stability 239

multi-layered stack 240, 241

operating parameters 245

OTFT 241

potential applications and functional  
properties 235

properties 229

quantitative study 243

self-supporting feature 239

SRR 239

steep sidewalls 239

three complex interconnect patterns  
237–239

threshold fluence 243

voxel separation mechanism 243

voxels transfer 229

- laser direct-write (LDW)
  - process 228
  - techniques 235, 299
- laser forward transfer process 6
- laser-guided direct writing (LGDW) 351
- laser-induced backward transfer (LIBT) 5, 252
  - beam-shaping 183
  - experimental setup 194
  - nanoimprinting approach 194
  - structured carrier substrate 195
  - transparent carrier 193
  - transparent receiver and transparent donor 193
  - unstructured carrier substrate 195
- laser-induced cavitation bubble 5
- laser induced forward transfer (LIFT) 3, 17, 252, 305, 307
  - advantages 20, 343
  - amyloid peptides 337, 338
  - composite-matrix-based materials 27
  - of DNA in solid and liquid phase 332, 333
  - donor substrate 22–23
  - DRL 24
  - early work 17–19
  - film-free laser printing 5
  - fluids, *see* fluids
  - HA-LIFT 28
  - limitations 22
  - liposomes 340, 343
  - liquid donor films 5
  - LITI 30–31
  - LMI 29
  - LP-LIFT 28, 29
  - MAPLE-DW 27
  - material transfer 19, 21, 22
  - of metals, *see* metals
  - odorant binding proteins 339
  - principle of operation 4, 5
  - printable inks 5
  - repairing damaged photomasks 19
  - soft materials, *see* soft materials
  - solid donor films 4
  - solid films (ceramics and polymers), *see* solid films (ceramics and polymers)
  - steps 20
  - streptavidin and avidin-biotin complex 333, 337
  - ultra-short laser pulses 25–26
  - viscosity and size of particles 5
- laser-induced molecular implantation technique (LIMIT) 8, 29
- laser-induced patternwise sublimation (LIPS) 7
- laser induced thermal imaging (LITI) 7, 30
- laser induced transfer process
  - technique, *see* laser induced forward transfer (LIFT) technique
- laser-induced transfer technology (LIT)
  - gold nanoparticles 252
  - hydrodynamic process 253
  - LIBT 252
  - LIFT 252
- laser molecular implantation (LMI) 8, 29
- laser pressure catapulting (LPC) 8
- laser printing 3
  - additive manufacturing method 266
  - bulk-silicon and silicon films
    - beam modification 256
    - computer-based image evaluation 256
    - femtosecond laser printing 258, 259
    - laser pulse energy 260
    - layer thickness 260
    - nanoparticle scattering properties 261
    - nanoparticles fabrication 260
    - normalized size distributions 256
    - processing steps 254
    - ring-shaped intensity distribution 256
    - ring shaped laser beam profile 256
    - scattering spectrum 261

- laser printing (*contd.*)
  - silicon wafer 254
  - SOI 259
  - of conducting layers 279
  - of dielectric layers 277–279
  - metasurfaces 263
  - multi-stage process 264
  - nanoparticles 254
  - pre-structured films 261–263
  - ribbon 199
  - of semiconductor layer 275–277
  - spherical nanoparticles 251, 263
  - ultraflat optical element 263
- Lasersonic<sup>®</sup> LIFT
  - continuous wave laser source and fast modulation 397–399
  - data flow 385
  - digital printing market expectations and challenges 377–378
  - future directions 401
  - history of 376–377
  - inking units 390–392
  - large area, high throughput
    - LIFT/LIBT inline R2R-printing system 387, 388
  - print experiments and results 392–397
  - printing heads 388–390
  - special printing markets 378
  - special test pattern 399–401
  - synthetic approaches 392
  - time schemes 383–385
  - transparent inks 379–382
  - ultrafast pulse modulation 382–383
  - ultrafast scan 385–387
- laser transfer, structures and functioning
  - devices
    - chemically/plasma driven traditional etching techniques 435
  - dynamics process *see* dynamics process
  - early demonstrations 428–430
  - electronic systems 438
  - embedded electronics 437–438
  - flexible circuits 439
  - hybrid circuits 439
  - individual or multiple components 435
  - metal foils 436–437
  - patterned thin films 436
  - pick-and-place tools 440
  - self-assembly techniques 436
- lase-and-place 428, 432–435, 437, 440
- laser transfer universe 5–8
- laser writing (LW) 331
- LDT, *see* laser decal transfer (LDT)
- LIFT, *see* laser induced forward transfer (LIFT)
- LIFT of liquid films 307, 308
- LIFT of 3D metal structures
  - adhesion 407
  - characteristics 407
  - definition of 3D structures 405
  - demonstrators and potential applications 420–422
  - droplet impact and solidification 411–413
  - ejection phenomena 407
  - ejection regimes of pure metal picosecond 408–411
  - electrical properties 418–420
  - inclined pillars 420
  - mechanical properties 417–418
  - metal LIFT printed pillars 407
  - metallurgical microstructure 416–417
  - copper pillars 415
  - pulse duration and spot size 407
  - reproducibility 414
  - schematic representation of LIFT 406
  - solidification phenomena 406
  - surface roughness 406
  - thermally induced nozzle 408
  - transfer threshold fluence 407
- LIFT printed copper pillar 417
- LIFT-printed OTFT 276
- light-to heat-conversion (LTHC) 30
- liposomes 340, 343
- long-pulsed LIFT (LP-LIFT) 28

**m**

mass printing technologies 271  
 material laser recording (MTR) 331  
 Matrigel™ 362  
 matrix-assisted pulsed laser evaporation (MAPLE) 38  
 matrix-assisted pulsed laser evaporation direct write (MAPLE DW) 27, 39, 318, 333, 351  
 metals 149  
   numerical modeling of LIFT for metals 165–167  
   applications 150  
   beam pattern 149  
   deposited structures 163–165  
   deposition 150  
   droplet mode deposition  
     contact and non-contact configurations 160  
     copper droplets 162  
     donor film 161, 162  
     droplet velocity 163  
     fs excimer LIFT 160  
     jet instability 162  
     jetting phenomena 163  
     liquid jets 163  
     mechanism 163  
     microscale 3D printing 163  
     multiple droplets per laser pulse 162  
     nanosecond LIFT of aluminum 161  
     transfer droplet 161, 162  
   feature characteristics 149  
   metal films 149  
   parametric effects  
     donor-film gap spacing 156, 157  
     laser fluence and film thickness 154–156  
     pulse width 157–160  
   resolution 150  
   single-step process 150  
   thermal processes 151–153  
   time scale and fluence 167–169  
   transfer 150  
 microbatteries 286

micro-contact printing ( $\mu$ CP) 302, 330  
 microelectromechanical systems (MEMS) 239  
 microfluidic patterning 330  
 microscale 3D printing 163  
 Mie theory 261, 263  
 mobility ( $\mu$ ) 273  
 multilevel computer-generated holographic structure 25

**n**

nanocrystal quantum dots (NCQDs) 46  
 nano-hydroxyapatite (nHA) 367  
 nanoimprinting approach 194  
 nanolasers 251  
 nanomaterial enabled laser transfer (NELT) 8  
 nanoparticles 251  
   laser printing 254  
   printing process 251  
 nano-tip printing technique 303  
 nervous system 367  
 Newtonian glycerol solutions  
   experimental design 202  
   fluid properties and laser fluence 204, 205  
   jettability phase diagram 206–208  
   typical jetting regimes 202, 203  
 nickel-chrome (NiCr) resistors 285  
 non-contact digital technology 38  
 non-contact printing methods  
   electrospray deposition 304, 305  
   inkjet printing technique 304  
   photochemistry-based printing 303  
**o**  
 odorant binding proteins (OBPs) 339  
 one-dimensional thermal model 155  
 on/off current ratio ( $I_{\text{on}}/I_{\text{off}}$ ) 274, 275  
 optical chemical sensor 300  
 organic electronic devices 7  
 organic light-emitting diodes (OLEDs) 7, 30, 281, 282, 285  
 TP-LIFT 47–49

organic thin film transistor (OTFT)  
 241  
 laser printing of conducting layers  
 279  
 laser printing of dielectric layers  
 277–279  
 laser printing of semiconductor layer  
 275–277  
 operation and characteristics 272,  
 273, 275  
 single step printing 279, 280  
 organ printing 350

**p**

passive components 285, 287  
 photochemistry-based printing 303  
 photoinduced decomposition 21  
 photolithography 123  
 pin printing approach 301, 302  
 platinum and gold inclined pillars 422  
 pluming/splashing regime 202, 203  
 poly(butyl methacrylate) (PBMA) 8  
 poly(3,4-ethylenedioxythiophene)  
 polystyrene sulphonate  
 (PEDOT:PSS) 48  
 poly(ethyl methacrylate) (PEMA) 8  
 poly-3-hexylthiophene (P3HT)  
 semiconductor material 277  
 polyimide blistering layer 432  
 polymer laser-absorbing layer 93  
 polymer sacrificial layer 432  
 poly[2-methoxy-5-(2-ethylhexyloxy)-  
 1,4-phenylenevinylene]  
 (MEH-PPV) 281  
 poly(methylmethacrylate) (PMMA)  
 181  
 polymethyl methacrylate polymer layer  
 44  
 polyvinyl butyral (PVB) inks 396  
 power-law relaxation time model  
 208  
 pulsed laser deposition (PLD) 38  
 pump-probe imaging 94

**q**

quantum dot-based light emitting  
 diodes 285

**r**

Rayleigh–Plateau instability 96  
 reactive ion etching 254  
 reactive LIFT (rLIFT) 52–54  
 red-green-blue PFO pixel transfer 282  
 robotic micro-needle array fabrication  
 330

**s**

satellites 410  
 SAW biosensor arrays 339  
 “Scotch tape” test 164  
 screen printing 271  
 Seebeck coefficient 192  
 selective laser melting (SLM) 423  
 sequential laser printing 283  
 shadowgraphy studies 42, 45,  
 184, 288  
 ceramic thin films 184–186  
 compliant receivers 186–188  
 silicon-on-insulator (SOI) 259  
 silver split-ring resonators (SRR) 239  
 single step printing, OTFT device 279,  
 280  
 slot-die approach 23  
 soft materials 199  
 jet formation, *see* jet formation  
 dynamics  
 jet formation mechanism 200  
 jet morphology 200  
 jet velocity 200  
 laser printing applications 218, 219  
 multilayer hydrogel-cell planar  
 structure 201  
 sol–gel technique 301  
 solid films (ceramics and polymers)  
 175  
 energy harvesting  
 chalcogenide thin films 189–190



- micro-scale thermoelectric generator 188
  - thermoelectric generator 190–193
  - laser pulse interference-assisted LIFT
    - BLAST 177–179
    - standing wave interference from multiple layers 176–177
  - LIBT
    - experimental setup 194
    - ion beam milling/UV beam machining 194
    - nanoimprinting approach 194
    - structured carrier substrate 195
    - transparent carrier 193
    - transparent receiver and transparent donor 193
    - unstructured carrier substrate 195
  - polymer films, 181–183
  - pre-machined ceramic micro-discs, LIFT printing of 180–181
  - shadowgraphy studies
    - ceramic thin films 184–186
    - compliant receivers 186–188
  - solvent orthogonality 93
  - spatial light modulator (SLM) 235
  - spin coating 23, 37, 129, 130
  - spray coating technology 38
  - streptavidin 334
    - and avidin-biotin complex 333, 337
  - stroboscopic imaging techniques 432
  - surface acoustic waves (SAW)
    - biosensors 311
    - chemical sensors 318
  - surface tension 256
- t**
- tert-butyl acrylate (TBA) 49
  - thermoelectric generator 190–193
  - thermo-mechanical selective
    - laser-assisted die transfer 431
  - thin-film transistor-liquid crystal displays (TFT-LCD) 228
  - 3D structures 405
  - through silicon vias (TSVs) 420
  - time-resolved imaging of jet formation 67–69
  - time-resolved imaging of droplet deposition 69–71
  - tissue engineering
    - blood vessels 362
    - bone 365, 367
    - heart 364, 365
    - nervous system 368
    - skin 360, 362
  - traditionally packaged electronic components 427
  - triazene DRL-LIFT 285
  - triazene polymers (TP) 331
    - chemical structure 40, 41
    - front and back side ablation 41–42
    - higher ablation rates 41
    - LIFT
      - application 46
      - aryltriazene photopolymers 44
      - biomembrane model system 45
      - materials 44
      - OLEDs, 47–49
      - polystyrene microbeads 45
      - sensors, 49–52
    - PS-microbead pixel 46
    - UV-vis absorption spectrum 41
  - tri-color pixels 283
  - two-dimensional thermal model 166
  - two-temperature model 166
- u**
- ultra flat lens 264
  - ultra-short laser pulses 25–26
  - UV photolysis 150

**V**

viscoelastic alginate solutions  
  alginate concentration effects 214,  
  216  
  experimental design 208, 209  
  ink coating preparation 208  
  jettability phase diagram  
  215, 217  
  laser fluence effects 212, 215

  material properties 209  
  non-dimensional numbers 209  
  typical jetting regimes 209, 210  
voxel separation mechanism 243

**W**

Wenzel wetting 71  
wild-type OBP from bovine (wtbOBP)  
339